



哈爾濱工業大學
HARBIN INSTITUTE OF TECHNOLOGY

FUTURE
DESIGN
SCHOOL

Future Design School

HITSZ 2026 International Graduate Prospectus

Design | English-Taught Program

University Overview



HIT & HITSZ

- ✓ HIT: C9 League | **"Cradle of Engineers"**
- ✓ 2025–2026 US News Engineering: **3rd worldwide**
- ✓ **Top 10 global:** Environmental, Mechanical, Chemical, EEE
- ✓ HITSZ (est.2002): **Core of the Greater Bay Area**
- ✓ **14,000+** students; **2,000+** international (16%)
- ✓ **80%+** faculty with international experience



About Future Design School

- ✓ **Est.2024** | interdisciplinary innovation
- ✓ Campus: **110,783 m²**
- ✓ Programs: **Digital Media, Industrial Design**
International faculty from top global design institutions

Facilities & Achievements

FDS Facilities & Student Success

4 Experimental Centers

Materials & Processing

Intelligent Manufacturing & Assembly

Visual & Art

Data & Perception

20+ labs: CAVE, motion capture, robots, digital fabrication

Top 3 Global Design Awards

Ecure: iF + IDEA Award

Zentrix: Red Dot Design Concept

Global Partnerships

Global Collaboration & Exchange

Partners: France, Italy, Hong Kong

Art + Technology + Engineering

Workshops & summer programs | financial support

Focus: cross-culture, sustainability, industry

Aligns with Shenzhen: global innovation & design hub

Future Design School has launched collaborative programs with The Hong Kong Polytechnic University (Master of Design), summer study initiatives with HKUST and L'École de design Nantes Atlantique, and signed an MoU with the University of Bologna. It is further expanding partnerships with leading universities across Southeast Asia, Europe, and beyond.



Shenzhen Advantages

Why Shenzhen?

- ✔ "China's Silicon Valley"
- ✔ 30,000+ high-tech enterprises
- ✔ Huawei, Tencent, DJI, Ping An
- ✔ AI, biomedicine, new energy, digital economy
- ✔ 23°C annual temperature | international lifestyle

Graduate Prospects Career & Development

- ✔ High-quality, industry-recognized education
- ✔ Recruited by top firms: Huawei, Tencent, DJI, Mindray
- ✔ Greater Bay Area opportunities
- ✔ Full innovation ecosystem: industry, policies, alumni network

Program Basics

Design Program

Language: English

Standard duration: 3 years

Max duration: 4 years

Eligibility Admission Requirements

Non-Chinese citizens

Bachelor's degree | under 35

Good physical & mental health

Application Timeline Key Dates

Open: Feb 1, 2026

Deadline: May 20, 2026

Application Materials

Equired Documents

- 1.Passport (valid ≥ 2 years)
- 2.Bachelor certificate / pre-graduation
- 3.Transcripts
- 4.English: TOEFL ≥ 80 / IELTS ≥ 6.0 (no subtest lower than 5.5) / DET ≥ 115
- 5.CV (no gap > 6 months)
- 6.2 recommendation letters
- 7.Personal statement (500–800 words)
- 8.Portfolio: 5–10 works | PDF ≤ 20 MB
- 9.Physical exam (within 6 months)
- 10.Non-criminal record
- 11.Bank statement $\geq 60,000$ RMB
- 12.Application fee proof
- 13.Optional: achievements



Application Process

How to Apply Online Application

- PC: hitsz.at0086.cn/student
- Fill → upload → pay → submit
- Admission Steps

1. Preliminary review
2. Assessment: test / interview
3. Admission & scholarship decision
4. Official admission letter



Fee Structure

Cost Structure

Application fee: 400 RMB / 60 USD (non-refundable)

Tuition: 70,000 RMB/year

After enrollment

oInsurance: 800 RMB/year

oMedical check: 500 RMB

oResidence permit: 400 RMB/year

Scholarship Policy

FDS Entrance Scholarship (auto-consider)

Major: 50% waiver + 1,000 RMB/month

First: 50% waiver

Second: 40% waiver

Third: 35% waiver

Other Scholarships

Shenzhen Universiade International Scholarship :

35,000 RMB/year

Guangdong Government Outstanding International

Students Scholarship: 20,000 RMB/year

Can be combined with FDS scholarship

Accommodation

On-Campus Housing

First-year master: triple/quad rooms

First-come, first-served | NOT guaranteed

Must vacate after Year 1 summer

Upper years: Wait list only

Fees: official announcement



Contact

General Admissions

Phone: +86-755-86716144

Email: admissions@hit.edu.cn

Address: Room721, Building H, HITSZ, 518055

Academic Inquiries

Email: sisd@hit.edu.cn



Thank You Join FDS HITSZ Shape the Future of Design

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